IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	Docket No.:	Docket No.:				
Yoshitsugu Morita et al.	71,051-020	71,051-020				
Serial No.:	Group Art Unit:	Group Art Unit:				
10/550,839	2812					
Filed:	Confirmation No.:	Confirmation No.:				
September 23, 2005	5484					
For: Semiconductor Device And Meth Of Manufacturing Thereof	being transmitted via EFS	I hereby certify that the enclosed Information Disclosure Statement is being transmitted via EFS transmission to the Commissioner of Patents, PO BOX 1450, Alexandria, VA 22313-1450, on the date shown below.				
	9/15/06 Date	<u>/Sandra Barry/</u> Sandra Barry				
Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450	,					
INFORMATION DISCLOSURE STATEMENT						
Dear Sir: Applicant(s) submit(s) herewith patents, publications, or other information, of which they are aware that they believe may be material to the examination of this application, and in respect of which, there may be a duty to disclose in accordance with 37 C.F.R. §1.56.						
The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made (37 C.F.R. 1.97(g)), an admission that the information cited is, or is considered to be, material to patentability, or that no other material information exists. The filing of this Information Disclosure Statement shall not be construed as an admission against interest in any manner.						
X Submitted herewith is Form PTO/SB/08A and/or PTO/SB/08B (Modified) listing patents, publications, or other information for consideration by the Office.						
COPIES PROVIDED:						
X Legible copies of all items listed on Information Disclosure Statement publications, copies of U.S. applications that were filed Wrapper System.	 except copies of U.S. partitions that were filed on or after 	atents, U.S. patent application er June 30, 2003, and copies of				
Under 35 U.S.C. §120, this application relies on the earlier filing date of prior application Serial No. [], filed on []. The following references were submitted to and/or cited by the Office on this prior application and are therefore not required to be provided in this application:						

Information Disclosure State Page 2	ement				
In accordance with submitted with this or publications list	Information Di	isclosu	re Statement, and] is being is cumulative of the	e following patents
FOREIGN LANGUAGE DO	CUMENTS				
There are no forei	gn language do	ocumer	nts listed on Form	PTO/SB/08A.	
X English language	abstract for the	follow	ing non-English re	ferences are enclos	sed:
Foreign Patent			olication Date	Cited D	ee or Applicant of
JP 8-244			09/24/1996		ajima
JP 11-07	7733	(03/23/1999	Sasa	ki et al.
	ign language de lent of the Engl	ocume	nts are believed to	be the equivalent of identified below, when the below, when the below identified below iden	
Cit	Cited Art		English Equivalent		
	JP 2000-277551		US 6,743,389		
	00-334782			,554,598	
in the English lang	uage and indic isfaction of th	ating the	ne degree of releva virement (under 3	ancy found by the Ir	ting information not nternational Bureau)(3)) for a concise
	ntly understood	by the	individual designa	ted in 37 C.F.R. §1.	guage information is .56(c) most
Foreign Patent <u>Document</u> JP 8-244064	Explanation of Relevance The relevancy of this document as presently understood is obtained from the English language abstract which indicates that this document discloses a resin molding apparatus for fabricating a semiconductor and method using release film.				
JP 11-077733	the English I a resin mold molded with	The relevancy of this document as presently understood is obtained from the English language abstract which indicates that this document discloses a resin molding method and resin molding device wherein the resin is molded without damaging a wiring pattern to be formed on the face of a substrate where a semiconductor chip is mounted.			

Information Disclosure Statement Page 3
A concise explanation of the relevance of the following listed non-English language information is set forth in the above-identified specification:
<u>CERTIFICATION</u> :
X The Information Disclosure Statement transmitted herewith is being filed within three (3) months of the filing date of the application or date of entry into the national stage of an international application or before the mailing date of a first Office Action on the merits, whichever event occurs last. 37 C.F.R. §1.97(b). Accordingly, it is believed that no certification or fee is due.
The Information Disclosure Statement transmitted herewith is being filed after three (3) months of the filing date of the application or the date of entry into the national stage of an international application or after the mailing date of the first Office Action on the merits, whichever event occurred last but before the mailing date of either a final action under 37 C.F.R. §1.113 or a Notice of Allowance under 37 C.F.R. §1.311, whichever occurs first. Accordingly, I hereby certify that:
each item of information contained in the Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three (3) months prior to the filing of the Information Disclosure Statement; 37 C.F.R. §1.97(e)(1); OR
no item of information contained in the Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to my knowledge as the person signing this certification after making reasonable inquiry, no item of information contained in the Information Disclosure Statement was known to any individual designated in §1.56(c) more than three (3) months prior to the filing of this statement; 37 C.F.R. §1.97(e)(2); OR
Applicant elects the option to pay the fee set forth in 37 C.F.R. §1.17(p) for submission of an Information Disclosure Statement under 37 C.F.R. §1.97(c). If a check is not enclosed, please charge the \$180.00 IDS submission fee to Howard & Howard Attorneys PC Deposit Account No. 08-2789. A duplicate of this paper is enclosed.
The Information Disclosure Statement transmitted herewith is being filed After a Final Action under 37 C.F.R. §1.113, or After a Notice of Allowance under 37 C.F.R. §1.311, whichever occurs first, but is being filed on or Before Payment of the Issue Fee . Accordingly, I hereby certify that:
each item of information contained in the Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three (3) months prior to the filing of the statement; 37 C.F.R. §1.97(e)(1); OR
no item of information contained in the Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to my knowledge as the person signing this certification after making reasonable inquiry, no item of information contained in the Information Disclosure Statement was known to any individual designated in §1.56(c) more than three (3) months prior to the filing of this statement; 37 C.F.R. §1.97(e)(2); AND
Applicant hereby petitions for consideration of this Information Disclosure Statement; 37 C.F.R. §1.97(d)(2)(ii). If a check is not enclosed, please charge the petition fee of \$180.00 Howard & Howard Attorneys PC Deposit Account No. 08-2789 . A duplicate of this paper is enclosed.

The Commissioner is authorized to charge Howard & Howard Attorneys PC Deposit Account No. 08-2789 for any additional fees due hereunder.

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Respectfully submitted

Reg. No.: 46,295

/David M. LaPrairie/

David M. LaPrairie

<u>September 15, 2006</u>

Date

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